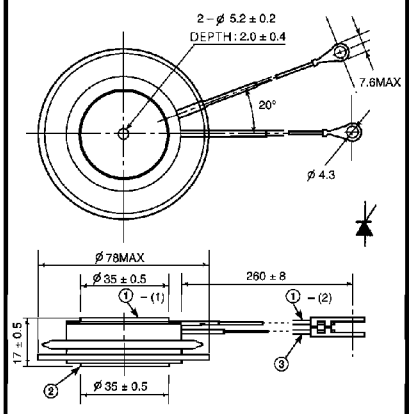
TOSHIBA ALLOY-FREE THYRISTOR

SF800U29

HIGH POWER CONTROL APPLICATIONS

- Repetitive Peak Off-State Voltage : V_{DRM} } = 1600V
- Repetitive Peak Reverse Voltage : V_{RRM} }
- Average On-State Current : $I_{T(AV)}$ = 800A
- Critical Rate of Rise of On-State Current : di / dt = 200A / μs
- Critical Rate of Rise of Off-State Voltage : dv / dt = 500V / μs
- Flat Package

Unit in mm



1-(1) CATHODE
1-(2) CATHODE (BLACK)
2. ANODE
3. GATE (WHITE)

JEDEC	—
EIAJ	—
TOSHIBA	13-78F1A

Weight : 250g

961001EAA1

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	V_{DRM} V_{RRM}	1600	V
Non-Repetitive Peak Reverse Voltage (Non-Repetitive < 5ms, T_j = 0~125°C)	V_{RSM}	1700	V
R.M.S On-State Current	$I_{T(RMS)}$	1260	A
Average On-State Current	$I_{T(AV)}$	800	A
Peak One Cycle Surge On-State Current (Non-Repetitive)	I_{TSM}	12000 (50Hz)	A
		13200 (60Hz)	
I^2t Limit Value	I^2t	720×10^3	A^2s
Critical Rate of Rise of On-State Current (Note)	di / dt	200	A / μs
Peak Gate Power Dissipation	P_{GM}	20	W
Average Gate Power Dissipation	$P_{G(AV)}$	4	W
Peak Forward Gate Current	I_{GM}	4	A
Peak Forward Gate Voltage	V_{FGM}	20	V
Peak Reverse Gate Voltage	V_{RGM}	5	V
Junction Temperature	T_j	−40~125	°C
Storage Temperature Range	T_{stg}	−40~125	°C
Mounting Force	—	14.7±1.5	kN

Note : V_D = 1 / 2 Rated, T_j = 120°C, Gate Supply (V_G = 15V, R_G = 8Ω, $t_r \leqq 1\mu s$)

ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN.	MAX.	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current	I_{DRM} I_{RRM}	$V_{DRM}=V_{RRM}=1600V$ $T_j=125°C$		—	35	mA
Peak On-State Voltage	V_{TM}	$I_{TM}=2500A$, $T_j=25°C$		—	2.15	V
Gate Trigger Voltage	V_{GT}	$V_D=6V$, $R_L=6\Omega$	$T_j=-40°C$	—	5.0	V
			$T_j=25°C$	—	4.0	
Gate Trigger Current	I_{GT}		$T_j=-40°C$	—	460	mA
			$T_j=25°C$	—	320	
Gate Non-Trigger Voltage	V_{GD}	$V_D=1/2$ Rated, $T_j=125°C$		0.2	—	V
Gate Non-Trigger Current	I_{GD}			5	—	mA
Delay Time	t_d	$V_D=1/2$ Rated, $T_j=25°C$ Gate Supply ($V_G=15V$, $R_G=8\Omega$, $t_r\leq 1\mu s$)		—	4	μs
Gate Turn-On Time	t_{gt}			—	6	μs
Holding Current	I_H	$T_j=25°C$, $R_L=6\Omega$		—	300	mA
Critical Rate of Rise of Off-State Voltage	dv / dt	$V_{DRM}=2/3$ Rated, $T_j=125°C$ Gate Open, Exponential Rise		500	—	V / μs
Thermal Resistance (Junction to Case)	$R_{th\,(j-f)}$	DC		—	0.04	°C / W